onsemi

XGS 16000 Global Shutter CMOS Image Sensor

XGS Family

Description

The XGS CMOS image sensor family provides high resolution, high performance global shutter image capture. This is a 16 MP 1.1 inch resolution variant that is hardware compatible to the XGS 12000 and lower XGS resolutions. The 21.5 mm x 19.5 mm package makes this sensor particularly suited for integration in 29 mm x 29 mm camera formats. The high speed, 12–bit output maximally leverages interfaces such as USB 3.2, ThunderboltTM 2 and 10 GigE.

Image data is read out through a column ADC architecture and then transferred over a HiSPi interface. On-chip logic, programmable via the serial interface, generates internal timing for integration and readout control. Up to three register configurations can be programmed and sequentially enabled (frame by frame) using a single command over the control interface.

Parameter		Typical Value				
Optical Format	XGS 16000	1.1 inch (18.1 mm Diagonal)				
Active Pixels	XGS 16000	4000 (H) x 4000 (V)				
Pixel Size	3.2 μm					
Color Filter Array	Monochrome, Bayer					
Shutter Type	Global Shutter					
Input Clock	32.4 MHz					
Output Interface	HiSPi (24 Lanes – 777.6 Mbps/lane)					
Frame Rate (12-bit)	24 Lanes (-X1)					
	XGS 16000	69 fps				
	12 Lanes (-X2)					
	XGS 16000	43 fps				
	6 Lanes (-X3)					
	XGS 16000	21 fps				
Read Noise	4 e ⁻ (1x), 1.9 e ⁻ (4x)					
SNR _{MAX}	40 dB					
Dynamic Range	68 dB					
Supply Voltages	1.2 V, 2.8 V, 3 V (0.4 V, 1.8 V Optional)					
Power Consumption	1 W (Full Speed, Full Resolution)					
Operating Temp.	-40°C to 85°C (Junction)					
Package	163-pin iLGA (Inspectable Land Grid Array)					

Table 1. KEY PERFORMANCE PARAMETERS

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Non-NDA Data Sheet

Interested in what you see? If you would like more detailed information, please request the full version of our data sheet.

Request Full Data Sheet

Features

- On-chip 12-bit Column ADCs
- 10-bit Mode with Increased Frame Rate of 76 fps (24-lane) at Full Resolution
- Companding and 10-Bit Mode at 52 fps (12-lane) and 26 fps (6-lane)
- Dual Gain Mode with 74.5 dB Dynamic Range (T_J = 40°C) at Half Frame Rate
- Data Interface: 24–lane HiSPi (Scalable Low–Voltage Signaling)
- Configurable Number of HiSPi Lanes: 24, 18, 12 or 6 Lanes
- Two–Wire (I²C) and Four–Wire (SPI) Serial Interface
- Triggered Integration and Readout Control
- Programmable Control for up to 64 Regions of Interest (ROI)
- Context Switching
- These Devices are Pb–Free, Halogen Free/ BFR Free and are RoHS Compliant

Applications

- Machine Vision
- Security
- Intelligent Transportation Systems (ITS)
- Broadcasting
- Medical
- Scientific

ORDERING INFORMATION

Table 2. ORDERABLE PART NUMBERS (Notes 1, 2)

Part Number	Product Description		Speed Grade	Resolution (H x V)	
NOIX1SE016KB-LTI	16 MP	Color	Production Device	24 lanes	4000 x 4000
NOIX1SN016KB-LTI	16 MP	Mono	Production Device		
NOIX2SE016KB-LTI	16 MP	Color	Production Device	12 lanes	
NOIX2SN016KB-LTI	16 MP	Mono	Production Device		
NOIX3SE016KB-LTI	16 MP	Color	Production Device	6 lanes	
NOIX3SN016KB-LTI	16 MP	Mono	Production Device		

1. See the onsemi Device Nomenclature document (TND310/D) for a full description of the naming convention used for image sensors. For reference documentation, including information on evaluation kits, please visit our web site at <u>www.onsemi.com</u>.
All devices listed in Table 2 are equipped with microlenses and optimized for a 0° Chief Ray Angle (zero-shift placement).

Table 3. ORDERING INFORMATION EVALUATION KITS

Part Number	Product Description	Additional Information		
NOIX1SN016KBLFB-GEVB	Sensor Headboard (16 MP, Mono, 24-Lane)	Demo Kit Headboard (incl. NOIX1SN016KB-LTI) (Note 3)		
NOIX1SE016KBLFB-GEVB	Sensor Headboard (16 MP, Color, 24-Lane)	Demo Kit Headboard (incl. NOIX1SE016KB-LTI) (Note 3)		
AGBAN6CS-GEVK	Frame Buffer Demo Board	AP21088 including Power Adapter		
AGB1N0CS-GEVK	Demo 3 Board	FPGA Base Board including USB Cable and Tripod		

3. Sensors are soldered to the headboard.





XGS Family

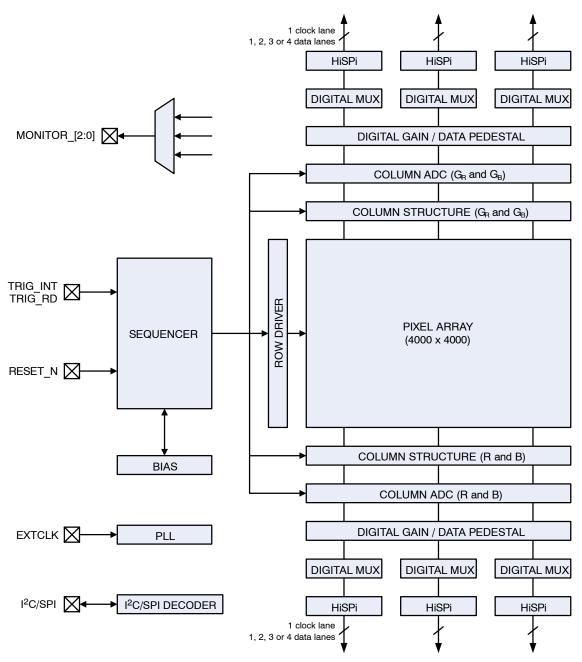


Figure 1. Functional Block Diagram (XGS 16000)

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ILGA163 21.5x19.5, 1P CASE 710AA **ISSUE C**

DATE 08 JUL 2020

2.500 MAX

163X

1.000 PITCH

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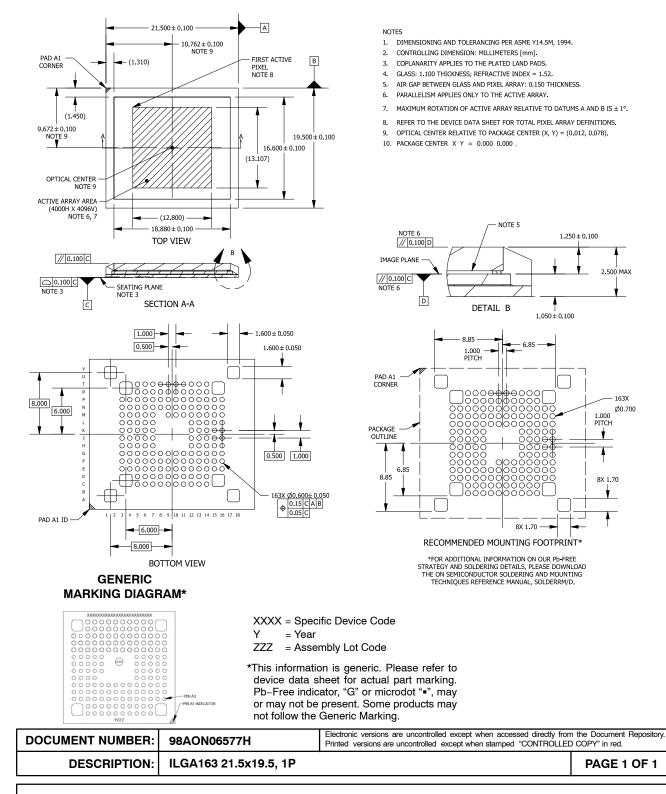
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